

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ying Chen	10/12/2011
Muhammed Zeyd Coban	10/12/2011
Wei-Jung Chien	10/12/2011
Marta Karczewicz	10/12/2011
Peisong Chen	10/10/2011

RECEIVING PARTY DATA

Name:	QUALCOMM Incorporated
Street Address:	5775 Morehouse Drive
City:	San Diego
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 5

Property Type	Number
Application Number:	13274196
Application Number:	61435271
Application Number:	61435281
Application Number:	61450545
Application Number:	61490557

CORRESPONDENCE DATA

Fax Number: (651)735-1102
 Phone: 651 735 1100
 Email: pairedocketing@ssiplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: Shumaker & Sieffert, P. A.
 Address Line 1: 1625 Radio Drive, Suite 300

CH \$200.00 13274196

501692176

**PATENT
 REEL: 027067 FRAME: 0775**

Address Line 4: Woodbury, MINNESOTA 55125

ATTORNEY DOCKET NUMBER:

1010-729US01/110877

NAME OF SUBMITTER:

Susan J. Daly

Total Attachments: 6

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ASSIGNMENT

WHEREAS, WE,

1. **Ying Chen**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,
2. **Muhammed Zeyd Coban**, a citizen of **The United States of America**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **Carlsbad, CA**,
3. **Wei-Jung Chien**, a citizen of **Taiwan**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,
4. **Marta Karczewicz**, a citizen of **The United States of America**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,
5. **Peisong Chen**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **COMBINED REFERENCE PICTURE LIST CONSTRUCTION FOR VIDEO CODING** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/274196 filed 10/14/2011, Qualcomm Reference No. **110877**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/435,271**, filed **January 22, 2011**, Qualcomm Reference No. **110877P1**, U.S. Provisional Application No(s). **61/435,281**, filed **January 22, 2011**, Qualcomm Reference No. **110877P2**, U.S. Provisional Application No(s). **61/450,545**,

filed **March 8, 2011**, Qualcomm Reference No. **110877P3**, and U.S. Provisional Application No(s). **61/490,557**, filed **May 26, 2011**, Qualcomm Reference No. **110877P4**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;


AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 10/12/2011
LOCATION DATE


Ying Chen

Done at SAN DIEGO on 10/12/2011
LOCATION DATE


Muhammed Zeyd Coban

Done at San Diego, on 10/12/11
LOCATION DATE


Wei-Jung Chien

Done at San Diego on 10/12/11
LOCATION DATE


Marta Karczewicz

Done at _____, on _____
LOCATION DATE

Peisong Chen

ASSIGNMENT

WHEREAS, WE,

1. **Ying Chen**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,
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4. **Marta Karczewicz**, a citizen of **The United States of America**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,
5. **Peisong Chen**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego, CA**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **COMBINED REFERENCE PICTURE LIST CONSTRUCTION FOR VIDEO CODING** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/274196 filed 10/14/2011, Qualcomm Reference No. **110877**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/435,271**, filed **January 22, 2011**, Qualcomm Reference No. **110877P1**, U.S. Provisional Application No(s). **61/435,281**, filed **January 22, 2011**, Qualcomm Reference No. **110877P2**, U.S. Provisional Application No(s). **61/450,545**,

filed **March 8, 2011**, Qualcomm Reference No. **110877P3**, and U.S. Provisional Application No(s). **61/490,557**, filed **May 26, 2011**, Qualcomm Reference No. **110877P4**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

